TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

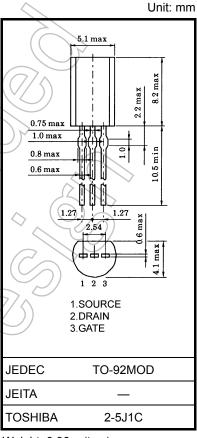
2SK3670

Chopper Regulator and DC-DC Converter Applications

- 2.5V-Gate Drive
- Low drain-source ON-resistance: R_{DS (ON)} = 1.0 Ω (typ.)
- High forward transfer admittance: |Y_{fs}| = 2.1 S (typ.)
- Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 150 V)
- Enhancement mode: V_{th} = 0.5 to 1.3 V (V_{DS} = 10 V, I_D =200 μA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Rating	Unit
Drain-source voltage			V_{DSS}	150	VV
Drain-gate voltage (R _{GS} = 20 kΩ)			V _{DGR}	150	V
Gate-source voltage			V _{GSS}	±12	V
	DC	(Note 1)	ΙD	0.67	
Drain current	Pulse (t ≤ s	5s) (Note 1)	I _{DP}	1	A
	Pulse	(Note 1)	I _{DP}	3	
Drain power dissipation			PD	0.9	W
Single pulse avalanche energy (Note 2)			EAS	41	m J
Avalanche current			(I _{AR})	0.67	JA
Repetitive avalanche energy (Note 3)			EAR	0.09	mJ
Channel temperature			, tch	150	→°C
Storage temperature range			T _{stg}	-55 to 150	°C



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

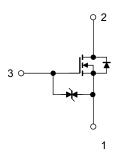
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	R _{th (ch-a)}	138	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DS} = 50V, T_{ch} = 25°C(initial), L = 135mH, I_{AR} = 0.67A, R_G = 25 Ω

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



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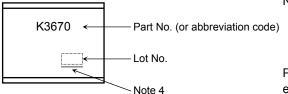
Electrical Characteristics (Ta = 25°C)

Charac	eteristics	Symbol	Test Condition		Тур.	Max	Unit
Gate leakage cu	rrent	I _{GSS}	V _{GS} = ±9.6 V, V _{DS} = 0 V		_	±10	μΑ
Drain cut-off cur	rent	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V		_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	150	_	_	V
Gate threshold v	roltage	V_{th}	V _{DS} = 10 V, I _D =200 μ A	0.5	/	1.3	V
Drain-source ON-resistance		R _{DS} (ON)	V _{GS} = 2.5 V, I _D = 0.5 A))1.1	2	Ω
			V _{GS} = 4 V, I _D = 0.5 A	7	1.0	1.7	
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 0.5 A	1.0	2.1	1	S
Input capacitano	e	C _{iss})	230	1	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	14	_	pF
Output capacitance		Coss			50	/	
Switching time	Rise time	t _r	5 V	- (16	<u> </u>	
	Turn-on time	t _{on}	0 V		40) —	20
	Fall time	t _f	50 Ω		23	ı	ns
	Turn-off time	t _{off}	Duty \leq 1%, $t_W = 10 \mu s$		95	1	
Total gate charge (gate-source plus gate-drain)		Qg		l	4.6	l	
Gate-source charge		Q _{gs}	$V_{DD} \approx 120 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 1 \text{ A}$	_	2.9	_	nC
Gate-drain ("miller") Charge		Qgd		_	1.7	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	0.67	Α
Pulse drain reverse current (t=5s) (Note 1)	I _{DRP}	_	_	_	1	Α
Pulse drain reverse current (Note 1)	IDRP	_	_	_	3	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 0.5 A, V _{GS} = 0 V	_	_	-1.5	V
Reverse recovery time	ţm	I _{DR} = 1A, V _{GS} = 0V	1	95	_	ns
Reverse recovery charge	√ Q _{rr}	dI _{DR} / dt = 50A / μs	_	110	_	nC

Marking



Note 4: A line under a Lot No. identifies the indication of product Labels.

[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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